SHEET 1 of 10

			Atty. Docket No.	Seria		101
INFORMATION DISCLOSURE		NMTI 1002-9		/068,513-366	6	
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EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
SIM	5,302,477	4/12/1994	Dao, et al.	430	5	8/21/1992
SPM	5,308,741	5/3/1994	Kemp	430	312	7/31/1992
SPM	5,324,600	6/28/1994	Jinbo, et al.	430	5	7/7/1992
SPM	5,364,716	11/15/1994	Nakagawa, et al.	430	5	9/3/1992
SPM	5,472,814	12/5/1995	Liu	430	5	11/17/1994
SPW	5,523,186	6/4/1996	Lin, et al.	430	5	12/16/1994
SPM_	5,527,645	6/18/1996	Pati, et al.	430	5	11/17/1994
5PM _	5,537,648	7/16/1996	Liebmann, et al.	395	500	8/15/1994
Spin	5,538,815	7/23/1996	Oi, et al.	430	5	9/14/1993
SHI	5,565,286	10/15/1996	Lin	430	5	11/17/1994
5lW	5,573,890	11/12/1996	Spence	430	311	7/18/1994
Selv	5,595,843	1/21/1997	Dao	430	5	3/30/1995
SILM	5,620,816	4/15/1997	Dao	430	5	10/13/1995
Sem	5,635,316	6/3/1997	Dao	430	5	10/13/1995
SKV	5,636,131	6/3/1997	Liebmann, et al.	364	490	5/12/1995
Spin	5,702,848	12/30/1997	Spence	430	5	8/23/1996
SPM	5,761,075	6/2/1998	Oi, et al.	364	488	5/31/1996
SRIN	5,766,804	6/16/1998	Spence	430	5	8/23/1996
DUN	5,766,806	6/16/1998	Spence	430	5	9/9/1996
5WM	5,807,649	9/15/1998	Liebmann, et al.	430	5	10/31/1996
SMr	5,858,580	1/12/1999	Wang, et al.	430	5	9/17/1997
Ser	5,923,562	7/13/1999	Liebmann, et al.	364	488	10/18/1996
8RL	5,923,566	6/13/1999	Galan, et al.	364	489	3/25/1997
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Spin	5,994,002	11/30/1999	Matsuoka	430	5	9/4/1997
SPM	5,998,068	12/7/1999	Matsuoka	430	5	1/27/1998
Bem	6,057,063	5/2/2000	Liebmann, et al.	430	5	4/14/1997
80W	6,066,180	5/23/2000	Kim, et al.	716	19	3/15/1999
SPM	6,083,275	7/4/2000	Heng, et al.	716	19	1/9/1998
81W)	6,130,012	10/10/2000	May, et al.	430	5	1/13/1999
8PW	6,139,994	10/31/2000	Broeke, et al.	430	5	6/25/1999
Sper	6,185,727 B1	2/6/2001	Liebmann	716	19	12/12/1995
8PM	6,228,539 BI	5/8/2001	Wang, et al.	430	5	1/12/1999
8PM	6,251,549 B1	6/26/2001	Levenson	430	11	10/28/1999
SPM _	6.258,493 B1	7/10/2001	Wang, et al.	430	5	7/17/2000
Sew	6,335,128 B1	1/1/2002	Cobb. et al.	430	5	9/28/1999
BRUM	6,338,922 B1	1/15/2002	Liebmann, et al.	430	5	5/8/2000
Sew	2001/0000240 A1	4/12/2001	Wang, et al.	430	5	12/7/2000
SPM	2001/0028985 A1	10/11/2001	Wang, et al.	430	5	4/20/2001

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INITIALS		201000				YES	NO
SIRM	JP 6-67403	3/11/1994	1P			Ø	
5RM	WO 01/23961 A1	4/5/2001	wo				
Sem	JP 1,283,925	2/14/1991	JP			×	
SIM	WO 02/03140 A1	1/10/2002	wo		$\overline{}$		
SIM	JP 2-140743	5/30/1990	1P			×	
SPM	GB 2,333,613 A	7/28/1999	GB				
Spin	JP 2,638,561	4/25/1997	JP				
Seln	JP 2,650,962	5/16/1997	JP				
\$ P.	EP 0 653 679 A2	5/17/1995	EP	-	,		
SK	JP 8,051,068	2/20/1996	JP			X	
der	JP 8-236317	9/6/1996	JP			Ø	
SM	JP 10-133356	5/22/1998	JP		,		
87A	JP 11-143085	5/28/1999	JР				
Sim	JP 62067547	3/27/1987	JP				
SPM)	WO 98/12605 A1	3/26/1998	wo				
SKM	DE 195 45 163 A1	6/5/1996	DE				

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Applicant

PIERRAT, Christophe

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Applicant

PIERRAT, Christophe

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PIERRAT, Christophe

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PIERRAT, Christophe

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SRM	2002/0129327 A1	9/12/2002	Pierrat, et al.	716	19	11/15/2001
SRW	2002/0152454 A1	10/17/2002	Cote, et al.	716	21 .	6/7/2002
SPM	2002/0155363 A1	10/24/2002	Cote, et al.	430	5	6/7/2002

EXAMINER: Mohamedulla

Date Considered:

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FORMATION DISCLOSURE **CITATION**

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Applicant PIERRAT, Christophe TC 1700

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EXAMINER:	Mohamedolla	Date Considered:	10/24/03	
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